

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
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EPAS ID: PAT7211609

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
DAI-YING LEE	02/24/2020
MING-HSIU LEE	02/24/2020
RECEIVING PARTY DATA	
Name:	MACRONIX INTERNATIONAL CO., LTD.
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State/Country:	TAIWAN
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	17688961
CORRESPONDENCE DATA	
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NAME OF SUBMITTER:	DANIEL R. MCCLURE
SIGNATURE:	/Daniel R. McClure/
DATE SIGNED:	03/08/2022
	This document serves as an Oath/Declaration (37 CFR 1.63).
Total Attachments: 2	
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Attorney Reference: _____

ASSIGNMENT OF AND DECLARATION FOR APPLICATION FOR UNITED STATES LETTERS PATENT**WHEREAS** Dai-Ying LEE and Ming-Hsiu LEE

, hereinafter referred to collectively as the assignor and inventor, has invented a certain improvement relating to

SEMICONDUCTOR STRUCTURE AND MANUFACTURING METHOD FOR THE SAME said application being attached hereto; said application having been filed in the United States Patent and Trademark Office on _____, as Application Serial No. _____, and was amended on _____ (if applicable); the specification of which was filed under the Patent Cooperation Treaty on _____,

Serial No. _____, the United States of America being designated.

AND WHEREAS MACRONIX INTERNATIONAL CO., LTD., hereinafter referred to as the assignee or applicant, is desirous of acquiring the entire right, title and interest in and to said application, including any and all divisions and continuations thereof, and in and to said invention and any and all patents which may be granted therefor, including any and all renewals, reissues and prolongations thereof,

NOW THIS WITNESSETH, that for good and valuable consideration paid by said assignee to said assignor, the receipt of which is hereby acknowledged, said assignor hereby assigns, sells and transfers to said assignee, and said assignee's successors and assigns, the full and exclusive right, title and interest in and to said application, including any and all divisions and continuations thereof, and in and to said invention and any and all patents which may be granted therefor, including any and all renewals, reissues and prolongations thereof; said assignee, and said assignee's successors and assigns, to have, hold, exercise and enjoy the said application, including any and all divisions and continuations thereof, and the said invention and any and all patents which may be granted therefor, including any and all renewals, reissues and prolongations thereof, with all the rights, powers, privileges and advantages in anywise arising from or appertaining thereto, for and during the term or terms of any and all such patents when granted, including any and all renewals, reissues and prolongations thereof, for the use and benefit of said assignee, and said assignee's successors and assigns, in as ample and beneficial a manner as the said assignor might or could have held and enjoyed the same, if this assignment had not been made.

AND said assignor hereby agrees to perform, upon the request of said assignee, or said assignee's successors or assigns, any and all acts relating to the obtaining or to the asserting of said patents, including any and all renewals, reissues and prolongations thereof.

AND said assignor authorizes and requests the Commissioner of Patents and Trademarks to issue Letters Patent on said application, and on any and all divisions and continuations thereof, to said assignee, and said assignee's successors and assigns, in accordance herewith.

As an above-named inventor, I hereby declare that the above-identified application was made or authorized to be made by me, and that I am the original inventor or an original joint inventor of a claimed invention in the application.

I hereby acknowledge that any willful false statement made in this declaration is punishable under 18 U.S.C. 1001 by fine or imprisonment of not more than five (5) years, or both.

ASSIGNOR (SOLE OR FIRST INVENTOR):

Signature: Dai-Ying Lee

Legal Name: Dai-Ying LEE

Date: 2.24.2020

ASSIGNOR (SECOND INVENTOR):

Signature: Ming-Hsiu Lee

Legal Name: Ming-Hsiu LEE

Date: Feb. 24. 2020